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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN65HVD10D	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	-40 to 85	VP10
SN65HVD10DR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP10
SN65HVD10DR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP10
SN65HVD10DRG4	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP10
SN65HVD10P	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	65HVD10
SN65HVD10P.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	65HVD10
SN65HVD10QD	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	-40 to 125	VP10Q
SN65HVD10QDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP10Q
SN65HVD10QDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP10Q
SN65HVD10QDRG4	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP10Q
SN65HVD10QDRG4.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP10Q
SN65HVD11D	Obsolete	Production	SOIC (D) 8	-	=	Call TI	Call TI	-40 to 85	VP11
SN65HVD11DR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP11
SN65HVD11DR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP11
SN65HVD11DRG4	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP11
SN65HVD11P	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	65HVD11
SN65HVD11P.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	65HVD11
SN65HVD11QD	Obsolete	Production	SOIC (D) 8	-	=	Call TI	Call TI	-40 to 125	VP11Q
SN65HVD11QDR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP11Q
SN65HVD11QDR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP11Q
SN65HVD11QDRG4	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP11Q
SN65HVD11QDRG4.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	VP11Q
SN65HVD12D	Obsolete	Production	SOIC (D) 8	-	=	Call TI	Call TI	-40 to 85	VP12
SN65HVD12DR	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP12
SN65HVD12DR.A	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP12
SN65HVD12DRG4	Active	Production	SOIC (D) 8	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VP12
SN65HVD12P	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	65HVD12
SN65HVD12P.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	65HVD12
SN75HVD10D	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	0 to 70	VN10



0 to 70

0 to 70

0 to 70

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75HVD12

75HVD12

75HVD12



SN75HVD12P

SN75HVD12P.A

SN75HVD12PE4

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Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking
						(4)	(5)		
SN75HVD10DR	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	0 to 70	VN10
SN75HVD10P	Obsolete	Production	PDIP (P) 8	-	-	Call TI	Call TI	0 to 70	75HVD10
SN75HVD11D	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	0 to 70	VN11
SN75HVD12D	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	0 to 70	VN12
SN75HVD12DR	Obsolete	Production	SOIC (D) 8	-	-	Call TI	Call TI	0 to 70	VN12

Yes

Yes

Yes

NIPDAU

NIPDAU

NIPDAU

N/A for Pkg Type

N/A for Pkg Type

N/A for Pkg Type

50 | TUBE

50 | TUBE

50 | TUBE

Active

Active

Active

Production

Production

Production

PDIP (P) | 8

PDIP (P) | 8

PDIP (P) | 8

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN65HVD10, SN65HVD11, SN65HVD12:

● Enhanced Product : SN65HVD10-EP, SN65HVD12-EP

NOTE: Qualified Version Definitions:

• Enhanced Product - Supports Defense, Aerospace and Medical Applications